Bipolar Transistors Silicon PNP Epitaxial Type

2SA1162

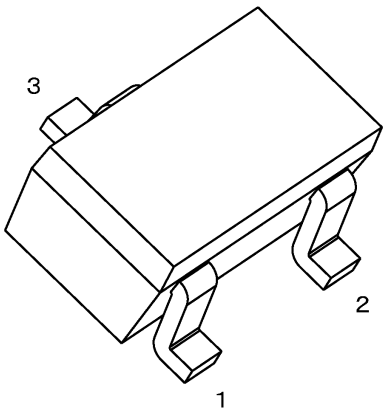
1. Applications

- Low-Frequency Amplifiers
- Audio Frequency General Purpose Amplifier Applications

2. Features

(1) AEC-Q101 qualified (Please see the orderable part number list)
(2) High voltage: V_{CEO} = -50 V
(3) High collector current: I_C = -150 mA (max)
(4) High h_{FE}: h_{FE} = 70 to 400
(5) Excellent h_{FE} linearity: h_{FE} (I_C = -0.1 mA)/h_{FE} (I_C = -2 mA) = 0.95 (typ.)
(6) Low noise: NF = 1 dB (typ.), 10 dB (max)
(7) Complementary to 2SC2712

3. Packaging



1: Base
2: Emitter
3: Collector

S-Mini

Start of commercial production
1982-12

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4. Orderable part number

Orderable part number		AEC-Q101		Note	
2SA1162-O	2SA1162-O,LF	—		General Use	
	2SA1162-O,LXGF	YES	(Note 1)	Unintended Use	(Note 1)
	2SA1162-O,LXHF	YES		Automotive Use	
2SA1162-Y	2SA1162-Y,LF	—		General Use	
	2SA1162-Y,LXGF	YES	(Note 1)	Unintended Use	(Note 1)
	2SA1162-Y,LXHF	YES		Automotive Use	
2SA1162-GR	2SA1162-GR,LF	—		General Use	
	2SA1162-GR,LXGF	YES	(Note 1)	Unintended Use	(Note 1)
	2SA1162-GR,LXHF	YES		Automotive Use	

Note 1: For more information, please contact our sales or use the inquiry form on our website.

5. Absolute Maximum Ratings (Note) (Unless otherwise specified, T_a = 25 °C)

Characteristics		Symbol	Rating	Unit
Collector-base voltage		V_{CBO}	-50	V
Collector-emitter voltage		V_{CEO}	-50	V
Emitter-base voltage		V_{EBO}	-5	V
Collector current (DC)		I_C	-150	mA
Base current		I_B	-30	mA
Collector power dissipation	(Note 2), (Note 4)	P_C	200	mW
	(Note 3)		150	
Junction temperature	(Note 2)	T_j	150	°C
	(Note 3)		125	
Storage temperature	(Note 2)	T_{stg}	-55 to 150	°C
	(Note 3)		-55 to 125	

Note: Using continuously under heavy loads (e.g. the application of high temperature/current/voltage and the significant change in temperature, etc.) may cause this product to decrease in the reliability significantly even if the operating conditions (i.e. operating temperature/current/voltage, etc.) are within the absolute maximum ratings.
Please design the appropriate reliability upon reviewing the Toshiba Semiconductor Reliability Handbook ("Handling Precautions"/"Derating Concept and Methods") and individual reliability data (i.e. reliability test report and estimated failure rate, etc).

Note 2: For devices with the ordering part number ending in LF(T.

Note 3: For devices with the ordering part number ending in XGF(T, XHF(T.

Note 4: Device mounted on an 25.4 mm × 25.4 mm × 1.6 mm FR4 glass epoxy board (Cu pad: 0.8 mm^2 × 3)

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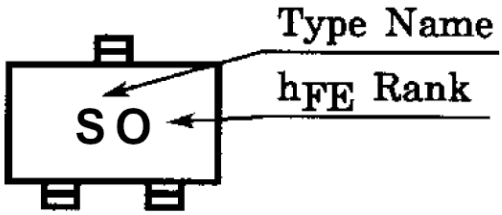
6. Electrical Characteristics (Unless otherwise specified, T_a = 25 °C)

Characteristics	Symbol	Note	Test Condition	Min	Typ.	Max	Unit
Collector cut-off current	I_{CBO}		V_{CB} = -50 V, I_E = 0 A	—	—	-0.1	μA
Emitter cut-off current	I_{EBO}		V_{EB} = -5 V, I_C = 0 mA	—	—	-0.1	μA
DC current gain	h_{FE}	(Note 5)	V_{CE} = -6 V, I_C = -2 mA	70	—	400	—
Collector-emitter saturation voltage	$V_{CE(sat)}$		I_C = -100 mA, I_B = -10 mA	—	-0.1	-0.3	V
Transition frequency	f_T		V_{CE} = -10 V, I_C = -1 mA	80	—	—	MHz
Collector output capacitance	C_{ob}		V_{CB} = -10 V, I_E = 0 A, f = 1 MHz	—	4	7	pF
Noise figure	NF		V_{CE} = -6 V, I_C = -0.1 mA, f = 1 kHz, R_G = 10 kΩ	—	1.0	10	dB

Note 5: h_{FE} classification O (O): 70 to 140, Y (Y): 120 to 240, GR (G): 200 to 400
( ) marking symbol

7. Marking



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8. Characteristics Curves (Note)

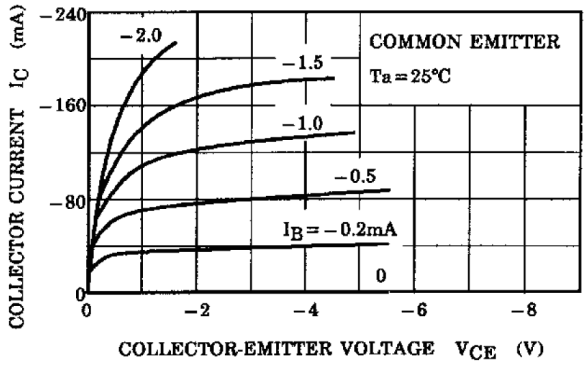

Fig. 8.1 I_C - V_{CE}

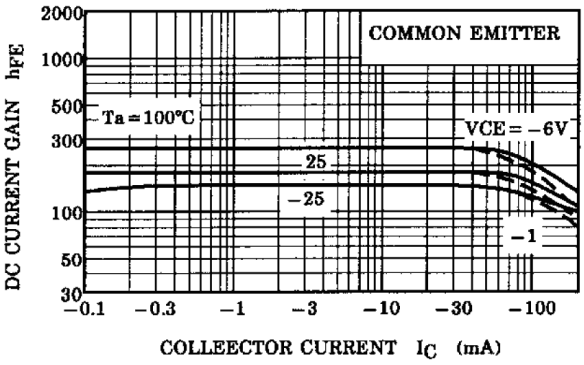

Fig. 8.2 h_{FE} - I_C

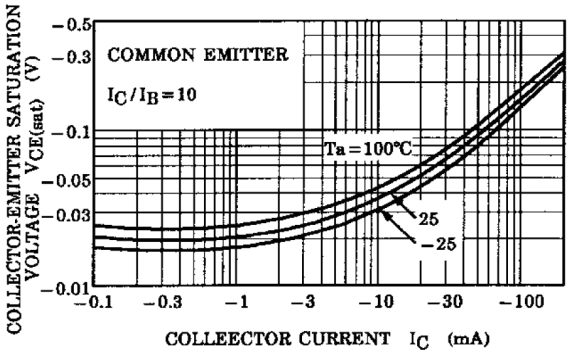

Fig. 8.3 $V_{CE(sat)}$ - I_C

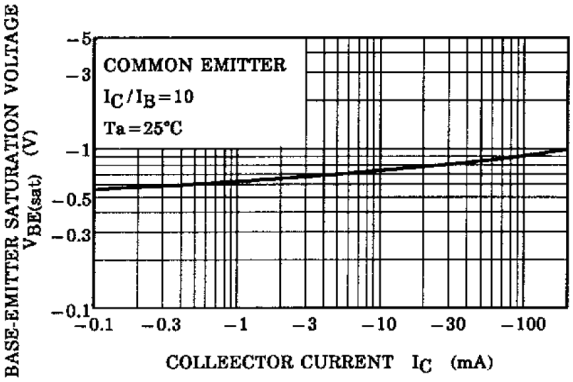

Fig. 8.4 $V_{BE(sat)}$ - I_C

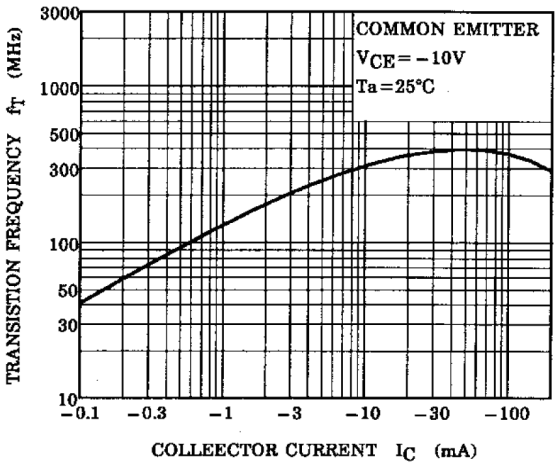

Fig. 8.5 f_T - I_C

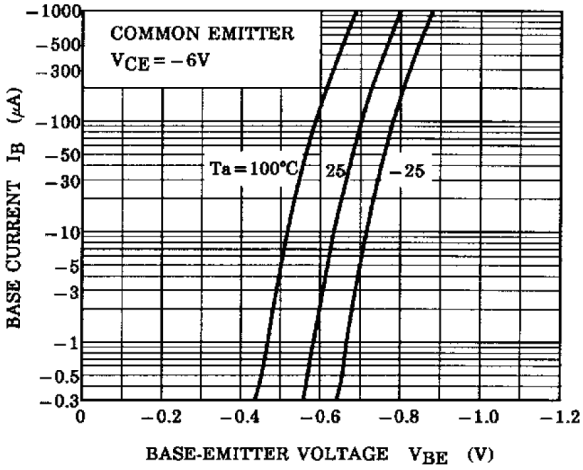

Fig. 8.6 I_B - V_{BE}

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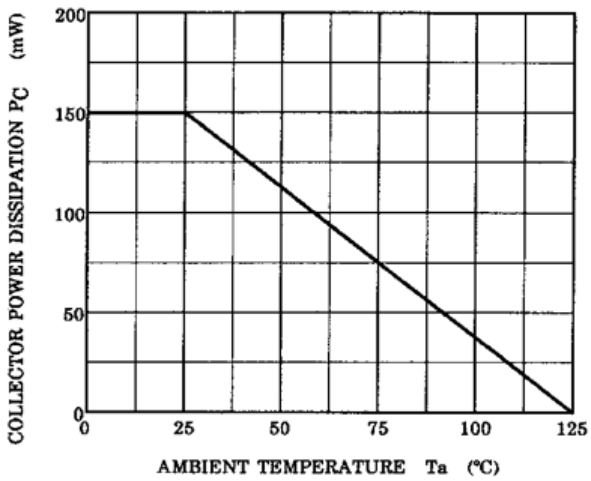

Fig. 8.7 P_C - T_a
Reference only with T_j of 125 °C.

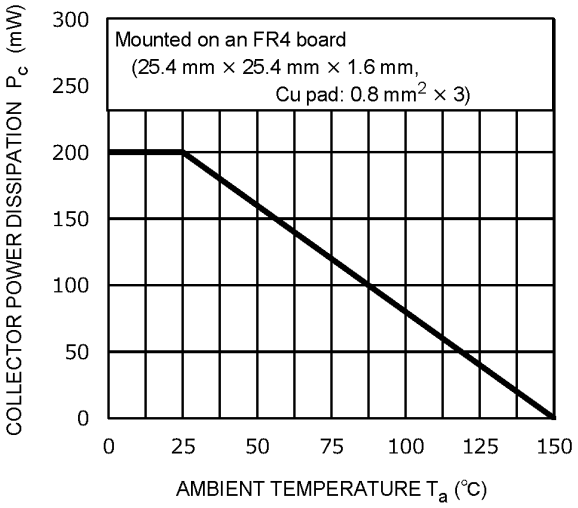

Fig. 8.8 P_C - T_a
Reference only with T_j of 150 °C.

Note: The above characteristics curves are presented for reference only and not guaranteed by production test, unless otherwise noted.

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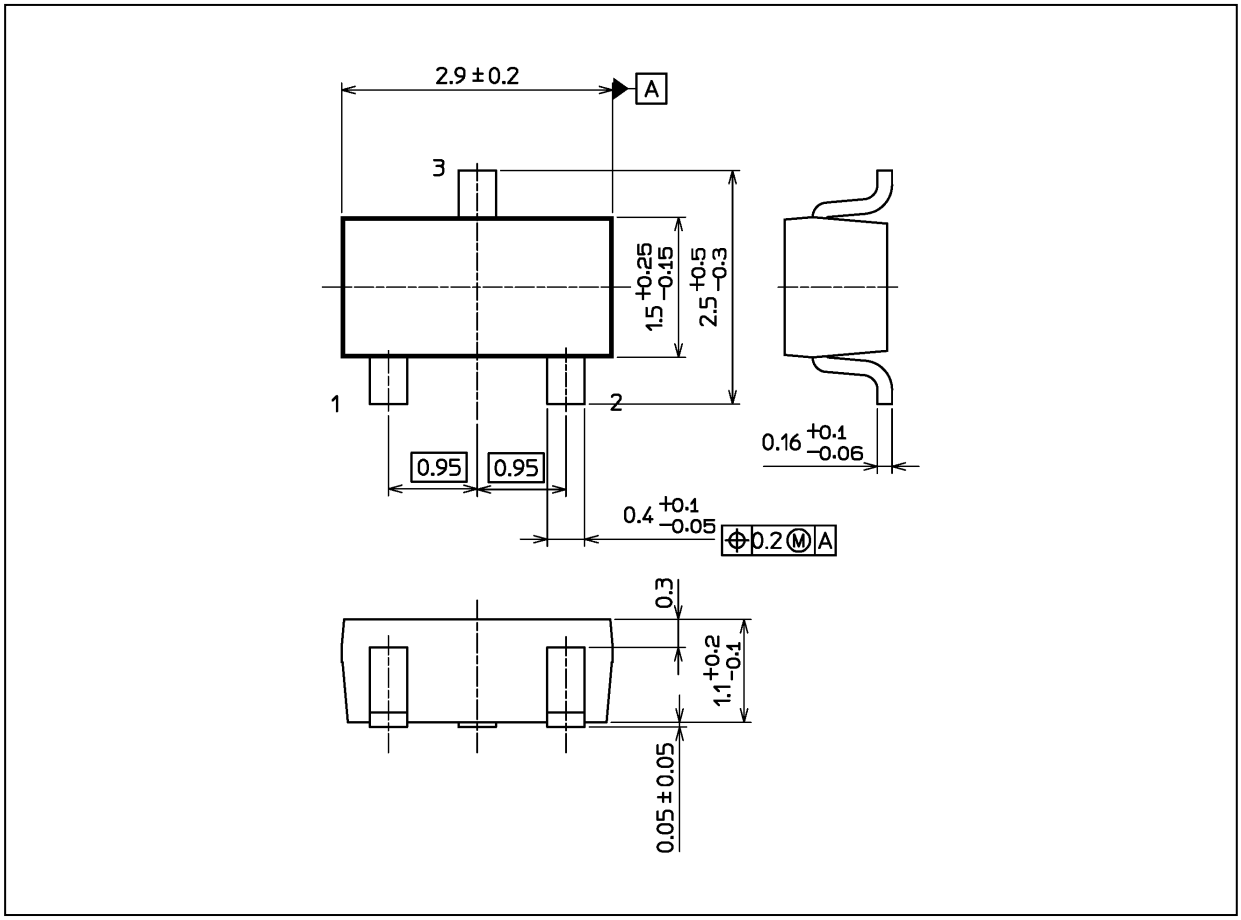
Package Dimensions

Unit: mm



Weight: 12 mg (typ.)

Package Name(s)
Nickname: S-Mini

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